

ABSTRACT OF THE DISCLOSURE

THERMOPLASTIC RESIN COMPOSITION

A thermoplastic resin composition comprising a heat-treated composition (1) obtained by heat-treating dynamically a specific polypropylene and an olefin copolymer rubber in the presence of an organic peroxide and a crosslinking agent and a specified polypropylene (2), and further, a composition prepared by incorporating an inorganic filler into the above-described thermoplastic resin composition.

These compositions are superior in mechanical properties such as flexural modulus, thermal rigidity, resistance and impact resistance, and can be suitably used for home electric parts and the like.